

Electronic Patent Application Fee Transmittal

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| Application Number: | 10707208 |
| Filing Date: | 26-Nov-2003 |
| Title of Invention: | INTEGRATED CIRCUIT DEVICE PACKAGE HAVING A SUPPORT COATING FOR IMPROVED RELIABILITY DURING TEMPERATURE CYCLING |
| First Named Inventor: | Viraj A. Patwardhan |
| Filer: | Justin A. White/Susan Xu |
| Attorney Docket Number: | NSC1P131X3 |

Filed as Large Entity

| Utility Filing Fees | | | | |
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| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
| Basic Filing: | | | | |
| Pages: | | | | |
| Claims: | | | | |
| Miscellaneous-Filing: | | | | |
| Petition: | | | | |
| Patent-Appeals-and-Interference: | | | | |
| Post-Allowance-and-Post-Issuance: | | | | |
| Extension-of-Time: | | | | |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
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| Miscellaneous: | | | | |
| Submission- Information Disclosure Stmt | 1806 | 1 | 180 | 180 |
| Total in USD (\$) | | | | 180 |